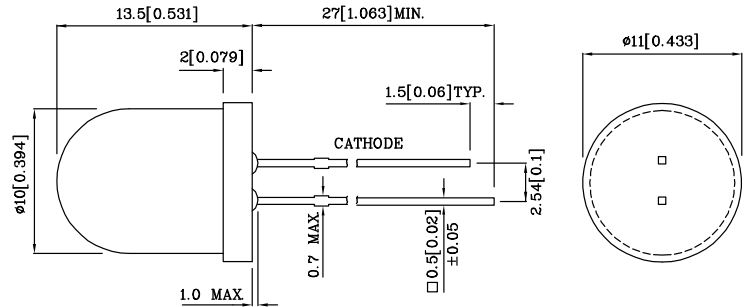


Features

- 10mm DIAMETER BIG LAMP WITH BUILT-IN BLINKING IC.
- OPERATION VOLTAGE FROM 3.5V to 14V.
- BLINKING FREQUENCY FROM 3.0Hz to 1.5Hz.
- RoHS COMPLIANT.



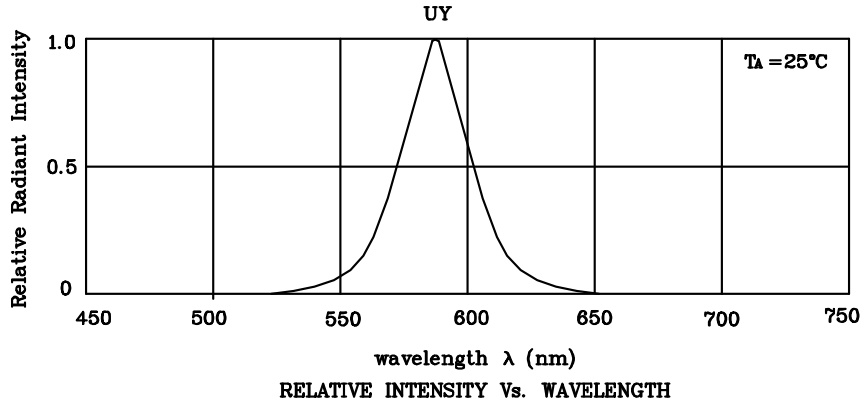
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.

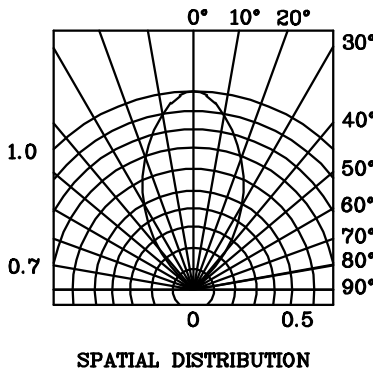
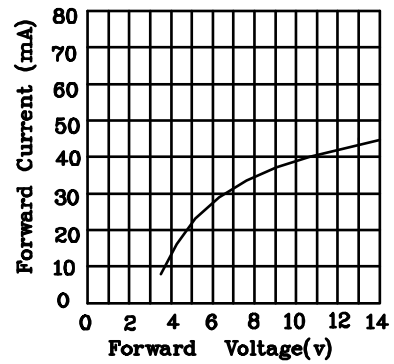
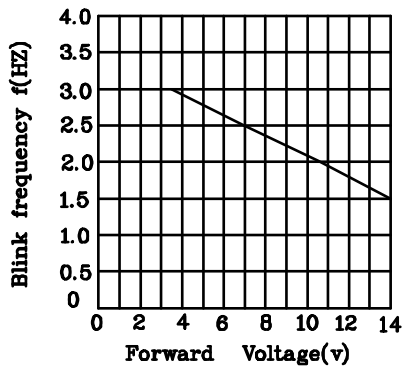
Absolute Maximum Ratings (TA=25°C)		UY (GaAsP/GaP)	Unit
Reverse Voltage	VR	0.5	V
Forward Voltage	VF	14	V
Power Dissipation	Pr	310	mW
Operating Temperature	TA	-40 ~ +70	°C
Storage Temperature	Tstg	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3 Seconds		
Lead Solder Temperature [5mm Below Package Base]	260°C For 5 Seconds		

Operating Characteristics (TA=25°C)		UY (GaAsP/ GaP)	Unit
Forward Current (Min.) (VF=3.5V)	IF	8	mA
Forward Current (Typ.) (VR=5V)	IF	22	mA
Supply Current VF=3.5V	ISON	8	mA
Supply Current VF=14V	ISON	44	mA
Blink Frequency VF=3.5V	f	3	Hz
Blink Frequency VF=14V	f	1.5	Hz
Wavelength of Peak Emission	λ P	590	nm
Wavelength of Dominant Emission	λ D	588	nm
Spectral Line Half- Width	Δλ	35	nm

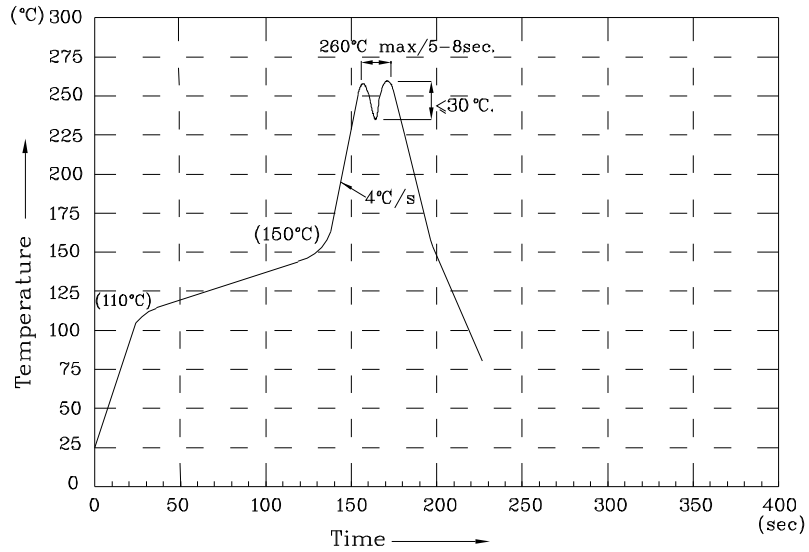
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (V= 9V) mcd		Wavelength nm λ P	Viewing Angle 2 θ 1/2
				min.	typ.		
XBUY01D	Yellow	GaAsP/GaP	Yellow Diffused	18	39	590	60°



❖ UY



Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85 degree°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.